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## Application Number

Filing Date

**First Named Inventor**

**Brian Christopher Hart**

**Group Art Unit**

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Attorney Docket Number

2001-0128.00

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IBM TECHNICAL DISCLOSURE BULLETIN, "Inhibiting Adhesion of Silicon Particles to the Surface of a Silicon semiconductor Wafer During Laser dicing," ( September 7, 1972).

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IBM TECHNICAL DISCLOSURE BULLETIN, "Coating protection for Laser Cutting and Welding Operations," ( January 7, 1976).

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IBM TECHNICAL DISCLOSURE BULLETIN, "Substrate Protective Coating Process," (November 7, 1978).

Re

POLYM.-PLAST. TECHNOL. ENG., 32 (1&2) 123-138 (1993), "Rheology of Water-Soluble Polymers: A comparative Study on the Effect of Monovalent Salt"

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